

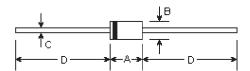
# **BY296 THRU BY299S**

FAST RECOVERY SILICON RECTIFIER
Reverse Voltage - 100 to 1000 Volts
Forward Current - 2.0 Amperes

#### **Features**

- Fast recovery diodes
- Diffused junction
- High current capability
- The plastic material carries U/L recognition 94V-0
- Terminals: Axial leads
- Polarity: Color band denotes cathode

#### DO-201AD



#### **Mounting Instruction**

- Min. distance from body to soldering point, 4mm
- Max. solder temperature, 350 °C
- Max. soldering time: 3.5 Sec.
- Do not bend lead at a point closer than 3mm to the body

DIMENSIONS									
DIM	inches		m	Note					
	Min.	Max.	Min.	Max.	Note				
Α	0.283	0.374	7.20	9.50					
В	0.189	0.208	4.80	5.30	ф				
С	0.048	0.051	1.20	1.30	ф				
D	1.000	-	25.40	-					

## **Maximum Ratings and Electrical Characteristics**

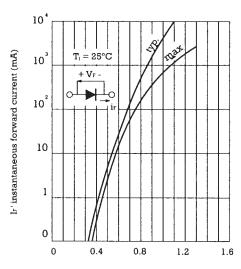
Ratings at 25°C ambient temperature unless otherwise specified.

	Symbols	BY296	BY297	BY298	BY299	BY299S	Units
Peak repetitive and non recurrent reverse voltage	V <sub>RRM</sub>	100	200	400	800	1000	Volts
Forward current, R load at T <sub>amb</sub> =50°C	I <sub>(AV)</sub>	2.0					
8.3mS peak forward surge current at T <sub>j</sub> =25 $^{\circ}$ C	I <sub>FSM</sub>		Amps				
Recurrent peak forward current (A)	I <sub>FRM</sub>	10.0					Amps
Maximum forward voltage drop at I <sub>F</sub> =2.0A	V <sub>F</sub>	1.3					Volts
Maximum reverse current at V <sub>RRM</sub> at 25 °C	I <sub>R</sub>	10.0					μА
Maximum reverse recovery time (Note 1)	T <sub>rr</sub>	250					nS
Maximum thermal resistance (I=10mm)	R <sub>⊕JA</sub>	30.0					°C/W
Operating and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +125					°C

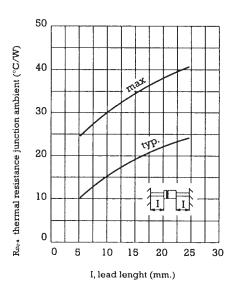
#### Note:

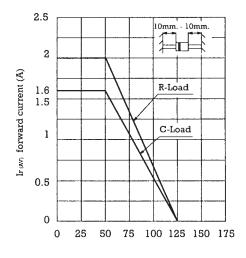
(1) Reverse recovery test conditions:  $I_e=0.5A$ ,  $I_p=1.0A$ ,  $I_r=0.25A$ 

## **RATINGS AND CHARACTERISTIC CURVES**



V<sub>F</sub> instantaneous forward voltage drop (V)





Tamb, ambient temperature (°C)

